

# TCT Studies in FZ, DOFZ and MCz Silicon

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Alison Bates\*, Michael Moll\* and Katharina Kaska\*\*

\* CERN, PH-TA1/SD Division

\*\* University of Technology, Vienna

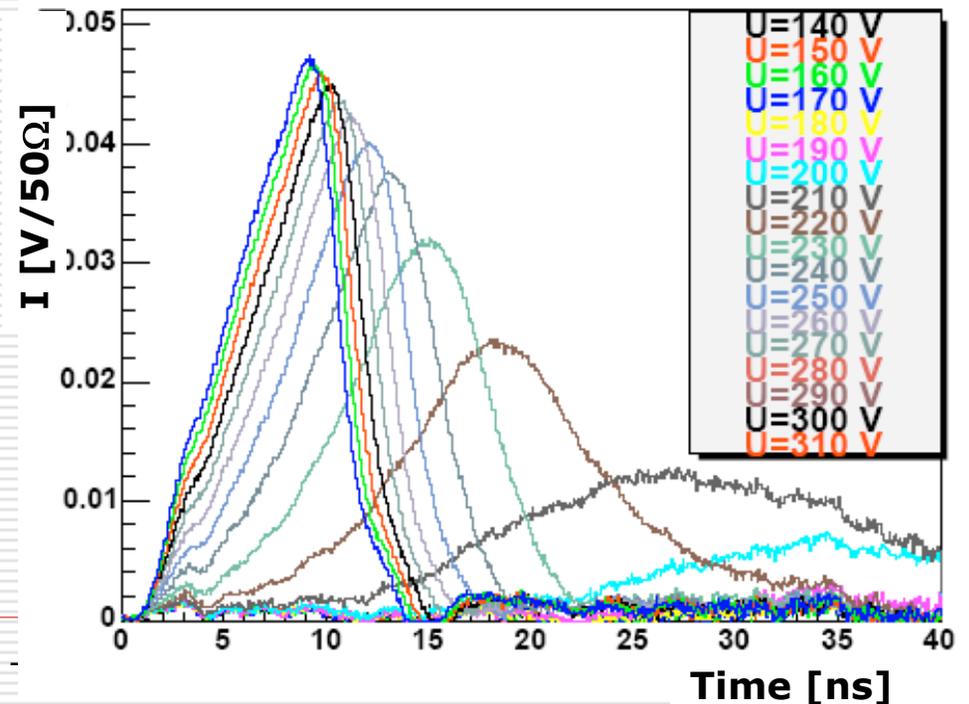
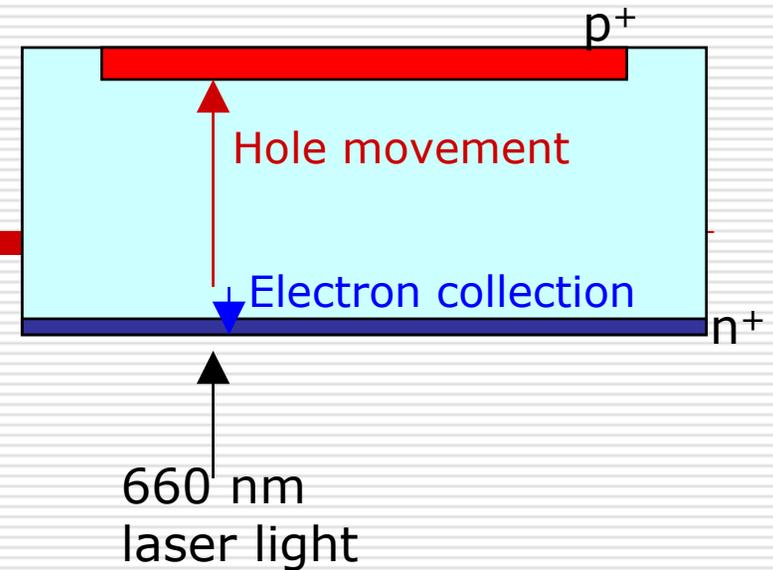
# Overview

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- Transient Current Technique review
- The new CERN TCT set-up
- Material characterisation
  - IV/CV
  - TCT
    - $QV \Rightarrow V_{fd}$
    - Trapping time determination
    - $\beta$  value determination
    - Type inversion in DOFZ
    - SCSI in MCz?

# TCT Review

- Illuminate front (p<sup>+</sup>) or rear (n<sup>+</sup>) side of detector with 660 nm photons
- Light penetrates only a few μm depth
- Ramo's theorem dictates signal will be dominated by one type of charge carrier
- $I(t) = q E(v(t)) v(t)_{\text{drift}}$
- e.g. hole dominated current (hole injection)
  - Illuminate rear (n<sup>+</sup>) side of detector



# CERN TCT set-up(1)

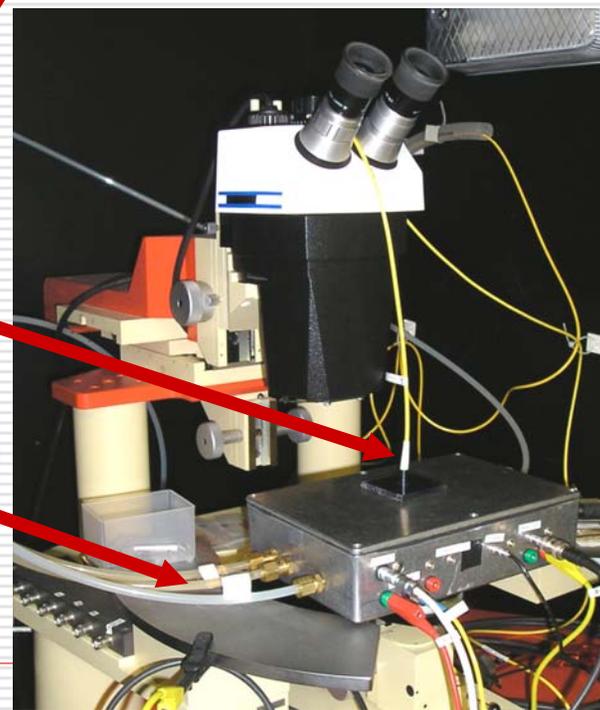
- Easy detector mounting
- Floating guard ring
- Front and back illumination possible
- Peltier cooled to  $\sim -10^{\circ}\text{C}$
- Temp. stability to  $\pm 0.1^{\circ}\text{C}$
- Flushed with  $\text{N}_2$  gas
- Red 660 nm laser diode
- IR 1060 nm laser diode
- Amount of charge deposited can be tuned - laser diode output controlled by pulse generator signal



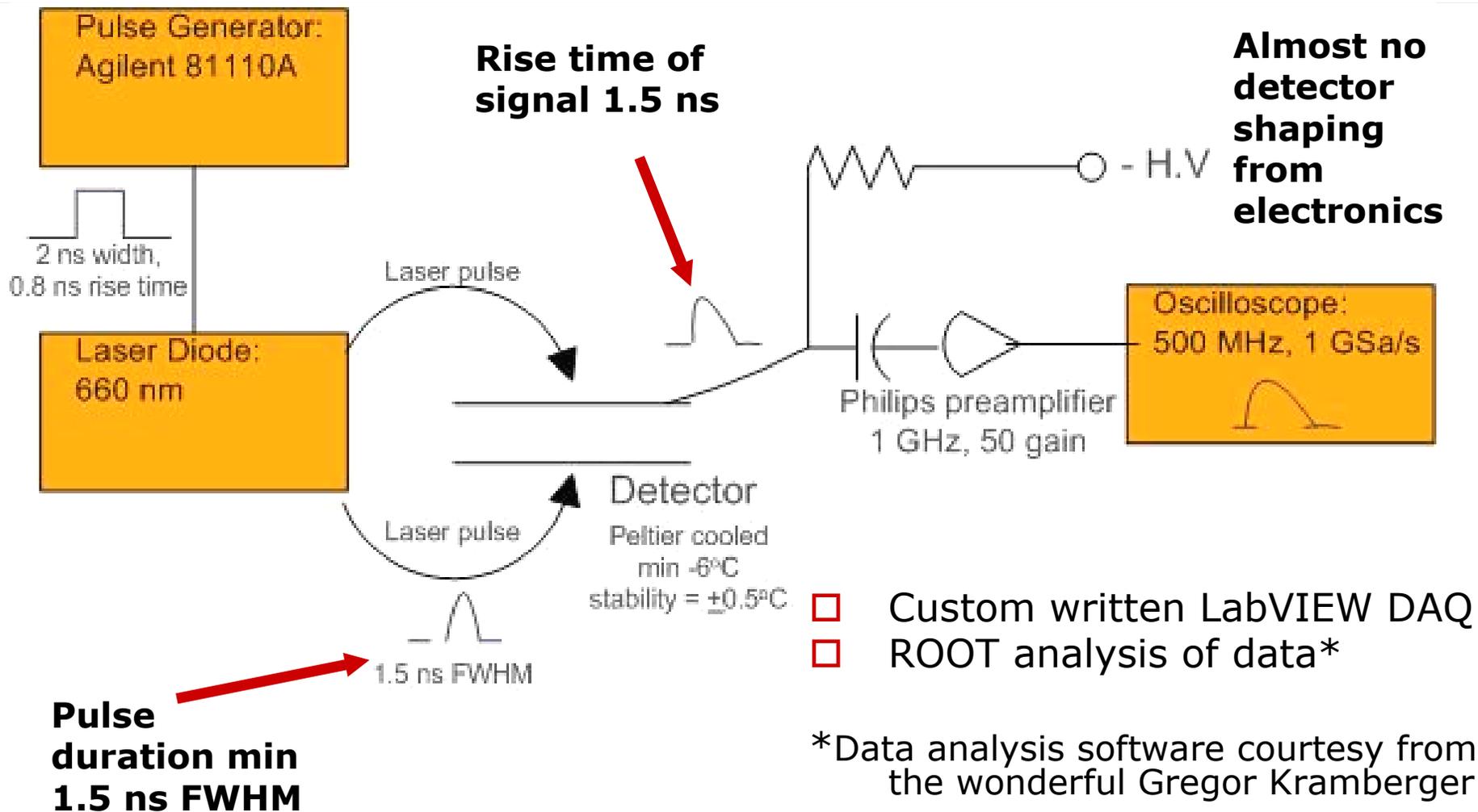
Au PCB for ground plate

Laser fibre for illuminating the top of the detector

Water cooling and gas system



# CERN TCT set-up(2)



# Materials studied

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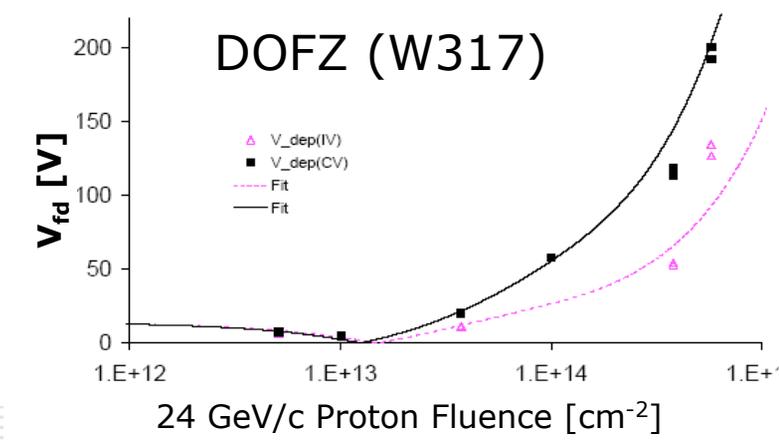
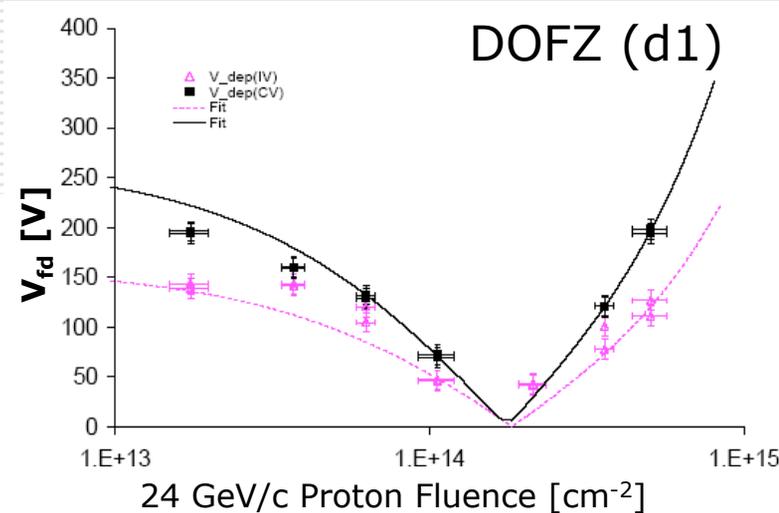
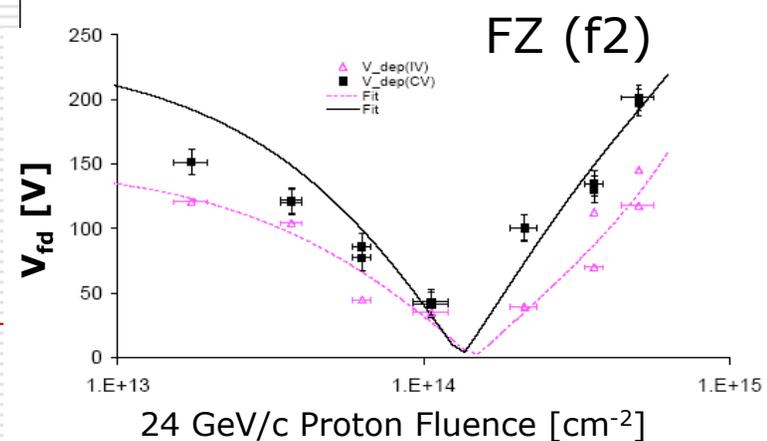
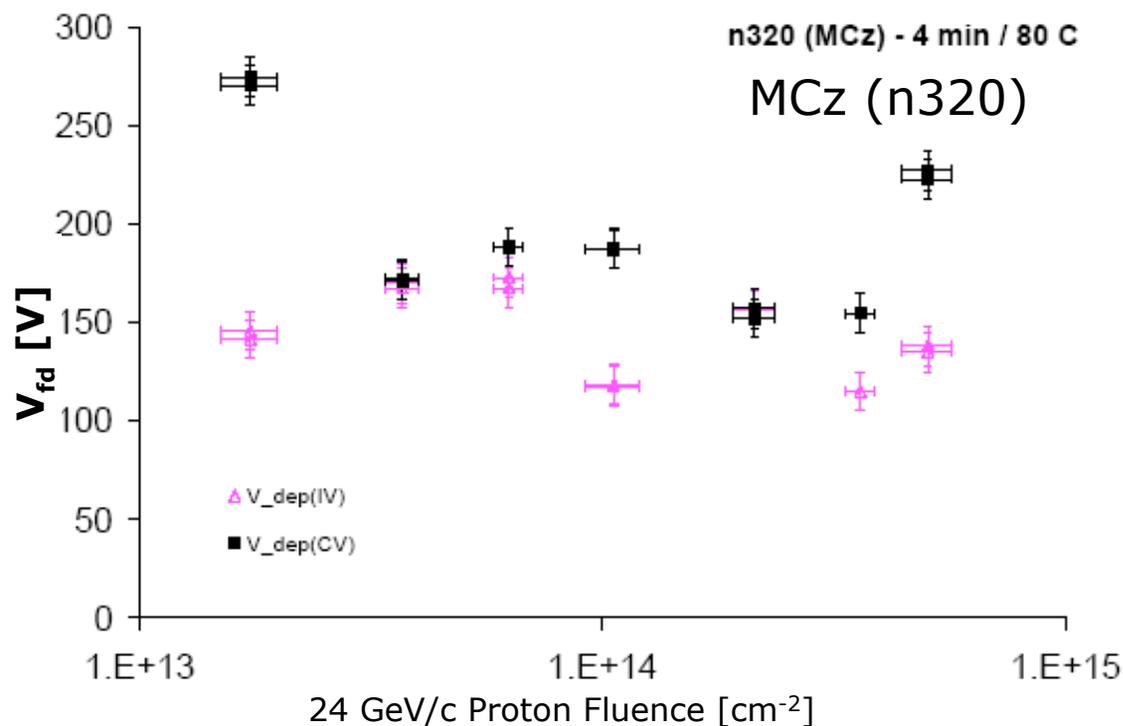
- Okmetic Oyj silicon processed at the Helsinki Institute of Physics\*
  - FZ (f2)
  - DOFZ (d1)
  - MCz (n320)
- 15 k $\Omega$ cm DOFZ (W317) silicon diodes
- All irradiations were performed at the CERN PS using 24 GeV/c protons\*\*

\*Many thanks (yet again!) to Jaakko Haerkonen and the Helsinki Institute of Physics

\*\* Maurice, Michael and Federico have now irradiated hundreds of detectors for these studies alone. They provide a truly unique service and are usually taken for granted!

# IV/CV analysis

- CV measurements - 10kHz
- Measurement at room temperature, then corrected to 20°C
- Guard rings grounded
- Annealed for 4 min / 80°C



# Normalised Leakage Current

- Annealed for 4 mins/80°C
- Normalise the leakage current to volume
- Using annealing parameterisation:

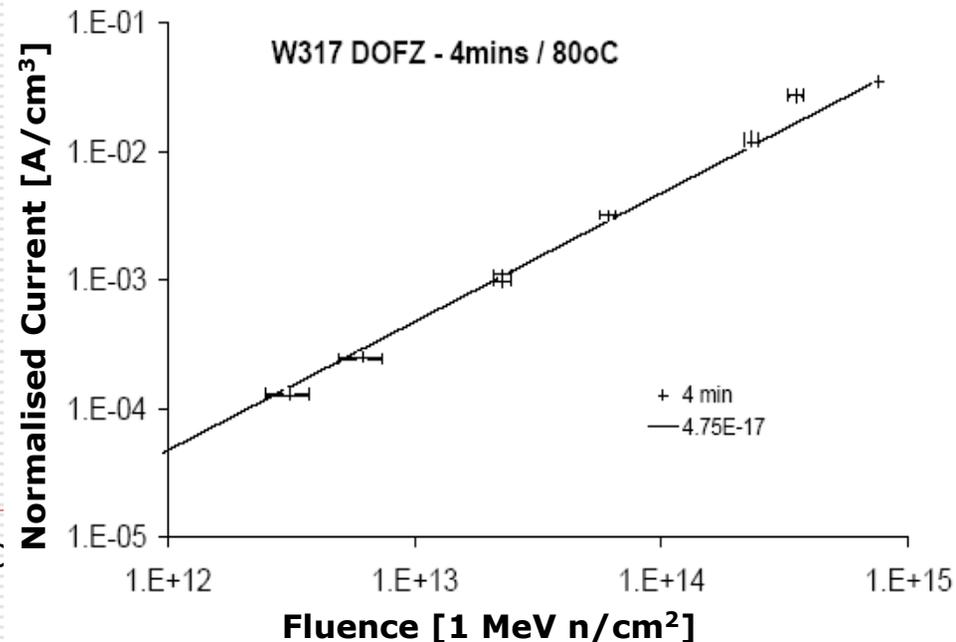
$$\alpha(t) = \alpha_1 e^{(-t/\tau_1)} + \alpha_0 - \beta \ln(t/t_0) \Rightarrow \alpha(4\text{mins}/80^\circ\text{C}) = 4.56 \times 10^{-17} \text{ A/cm}$$

**W317(DOFZ)  $\alpha = 4.75 \times 10^{-17} \text{ A/cm}$**

**f2 (FZ)  $\alpha = 4.96 \times 10^{-17} \text{ A/cm}$**

**d2 (DOFZ)  $\alpha = 4.85 \times 10^{-17} \text{ A/cm}$**

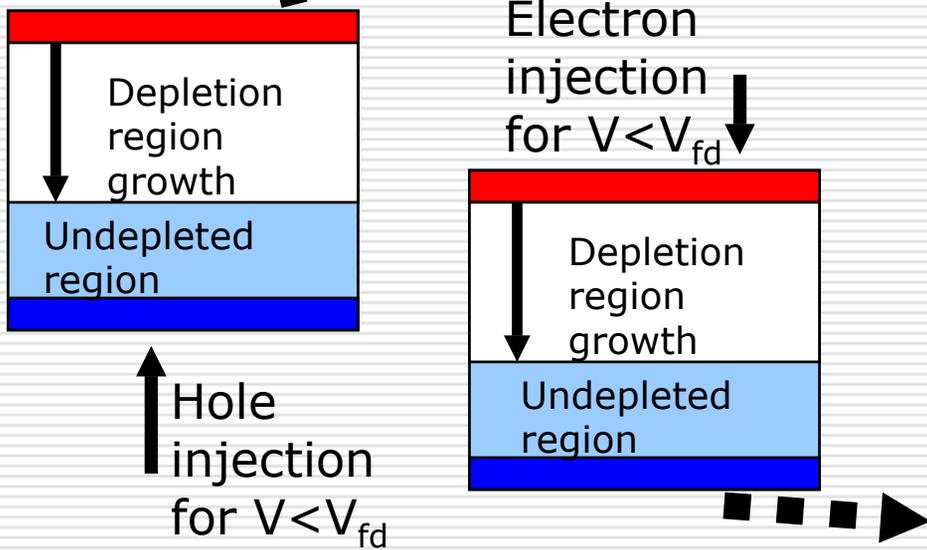
**n320 (MCz)  $\alpha = 4.73 \times 10^{-17} \text{ A/cm}$**



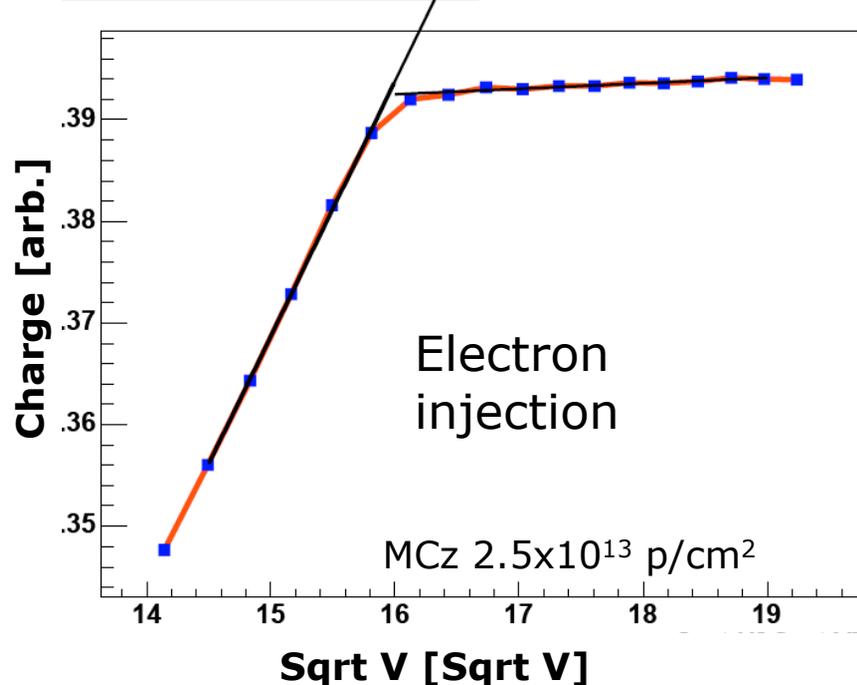
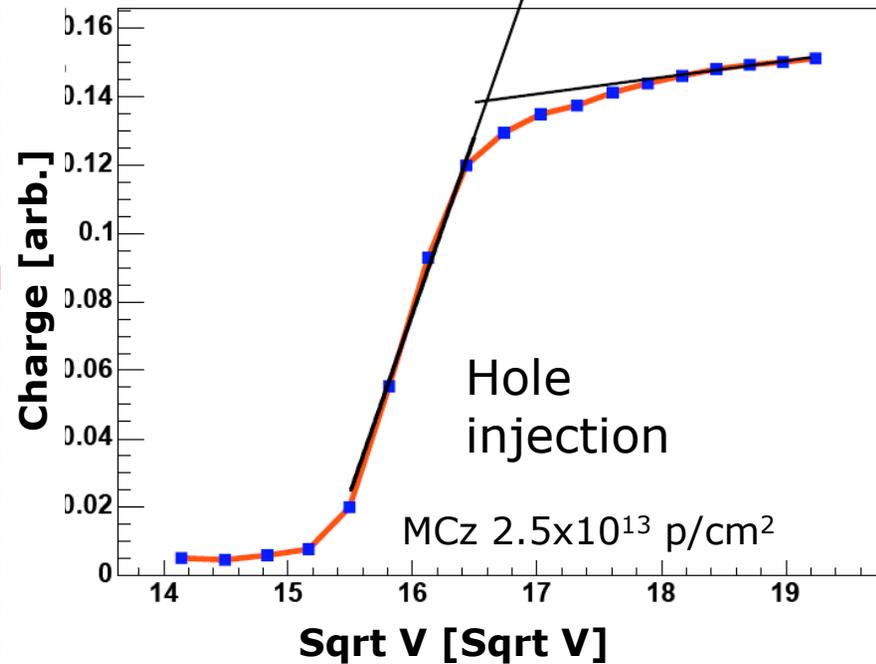
# TCT Results

## - QV method

- Charge collected as a function of voltage



Charge vs. Voltage @ T=+05 C



# QV compared with IV/CV

Brown Circles

● = QV (h injection)

Blue Triangles

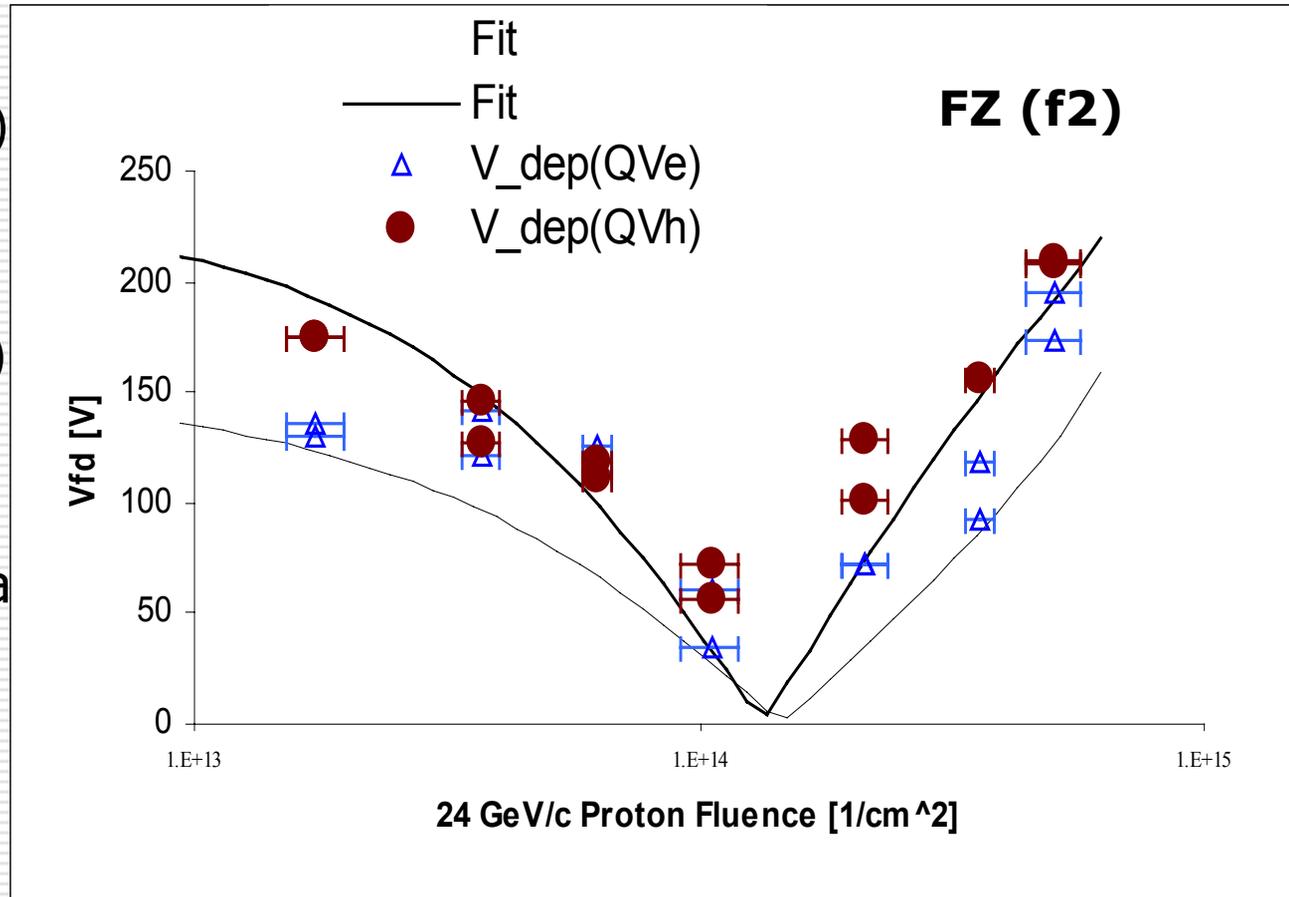
△ = QV (e injection)

Black solid line

— = fit from CV data

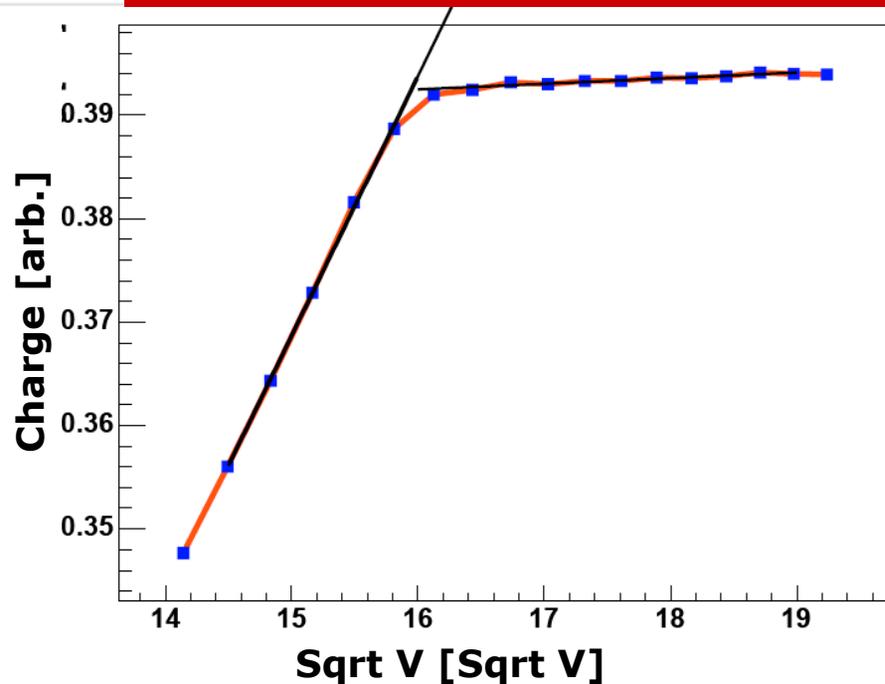
Purple dashed line

- - = fit from IV data



# Effective trapping time

## – Charge Correction Method (CCM)



Black = signal from oscilloscope

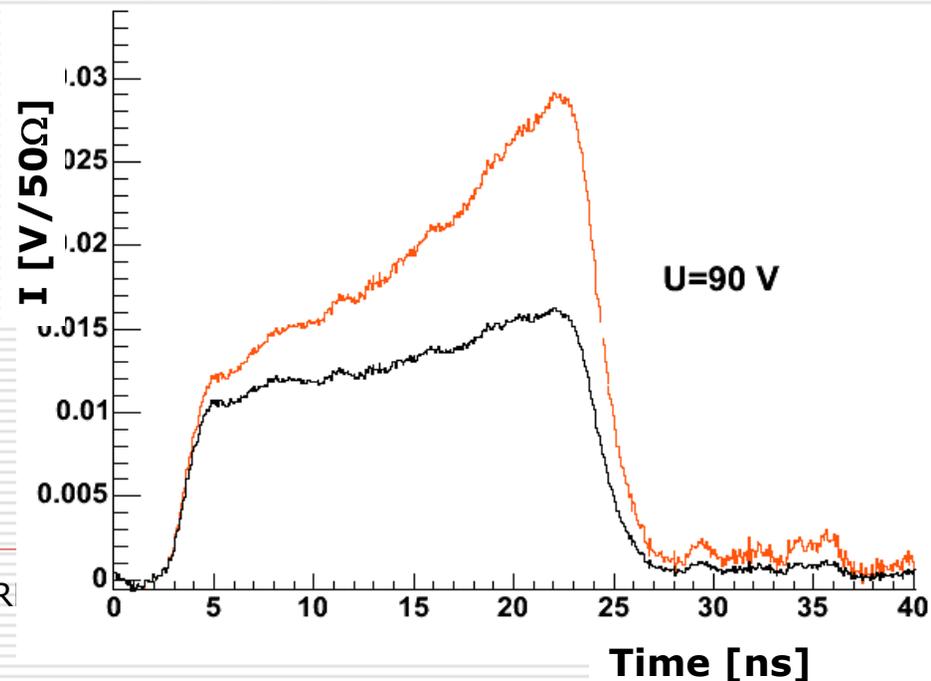
Red = signal corrected for trapping

For  $V > V_{fd}$ , then:

⇒ constant Q collected if no trapping

⇒ try various  $\tau_{eff}$  values

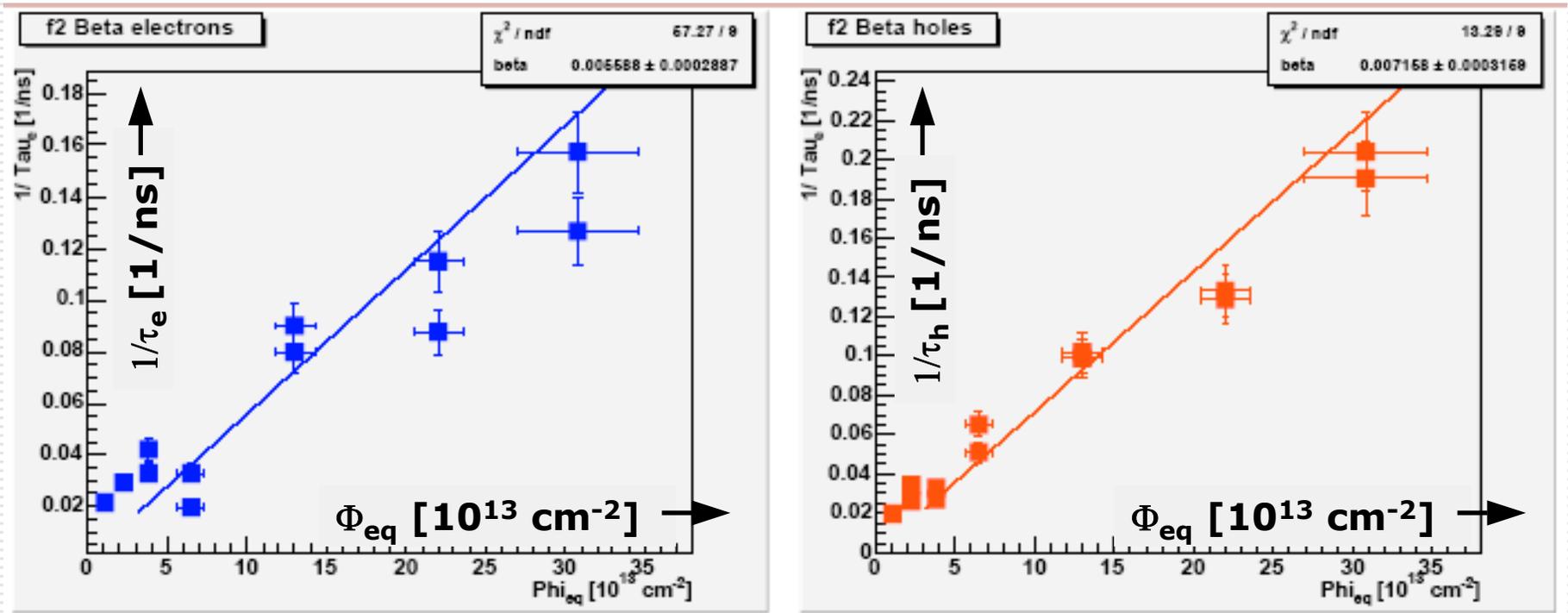
⇒ correct  $\tau_{eff}$  value is when gradient of this line is zero



# $\beta_{e,h}$ values

$$1/\tau_{\text{effe,h}} = \beta_{e,h} \Phi_{\text{eq}}$$

Example plots from FZ (f2);



Electron Injection

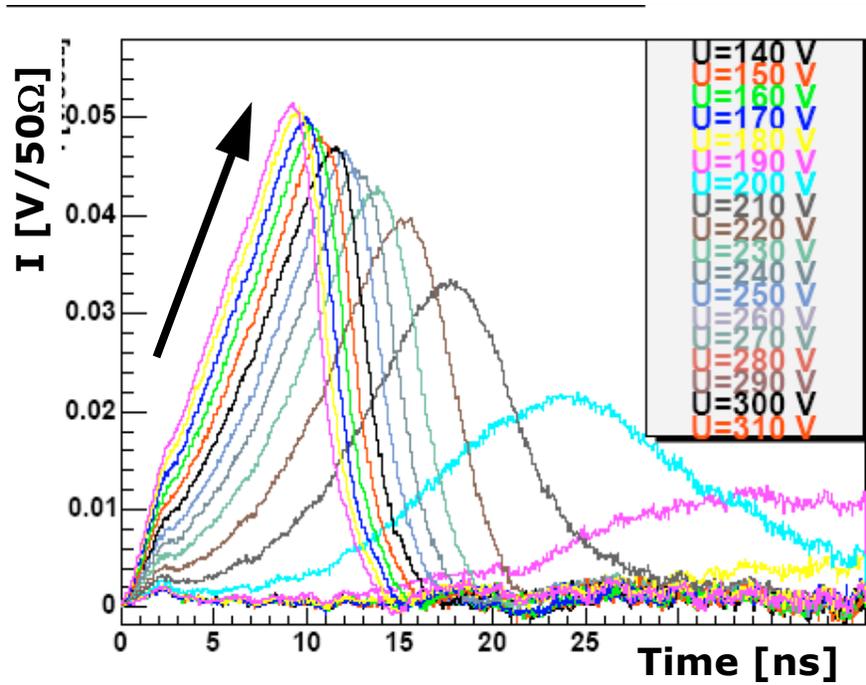
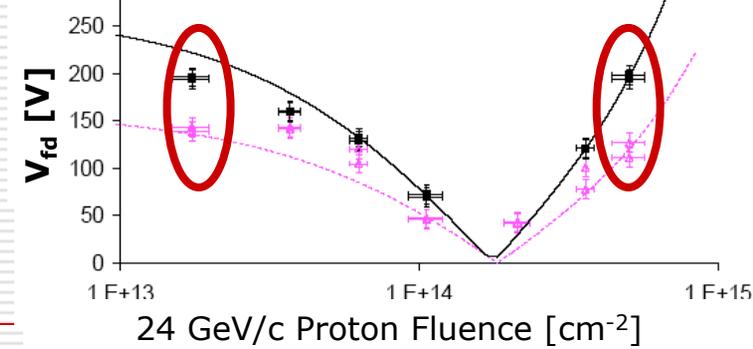
Hole Injection

# $\beta$ parameter summary

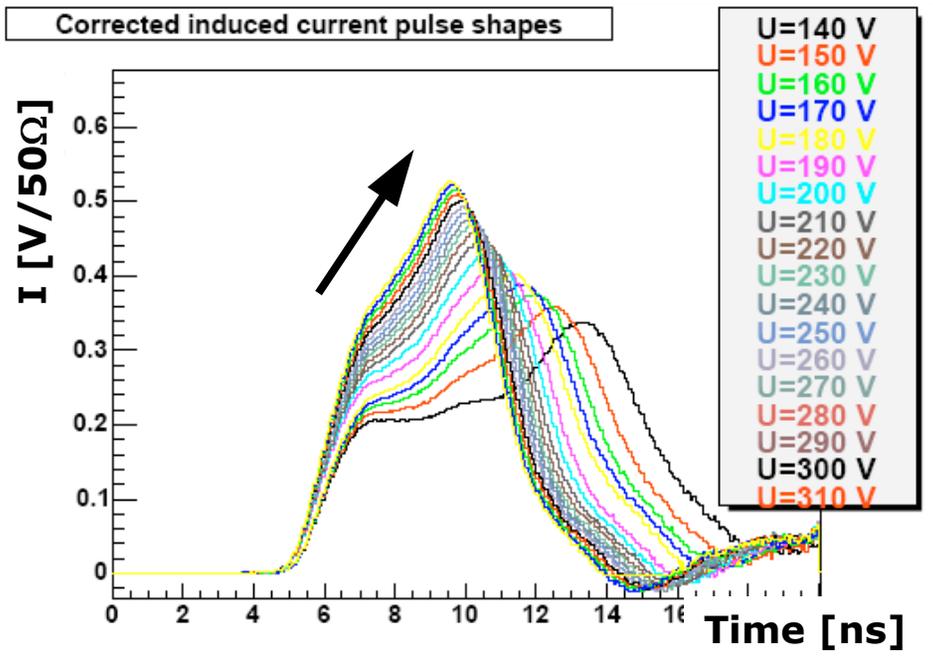
	$\beta_e$ [ $10^{-16}$ cm <sup>2</sup> /ns]	$\beta_h$ [ $10^{-16}$ cm <sup>2</sup> /ns]	T [°C]
Dortmund	5.16 $\pm$ 0.16	5.04 $\pm$ 0.16	0
Ljubljana	5.6 $\pm$ 0.2	7.7 $\pm$ 0.2	-10
Hamburg	4.85 $\pm$ 0.15	5.72 $\pm$ 0.5	+20
f2 (FZ)	5.59 $\pm$ 0.29	7.16 $\pm$ 0.32	+5
d1 (DOFZ)	5.73 $\pm$ 0.29	6.88 $\pm$ 0.34	+5
<i>n320 (MCz)</i>	5.81 $\pm$ 0.32	7.78 $\pm$ 0.39	+5
W317 (DOFZ)	5.48 $\pm$ 0.22	6.02 $\pm$ 0.29	+5

New results!

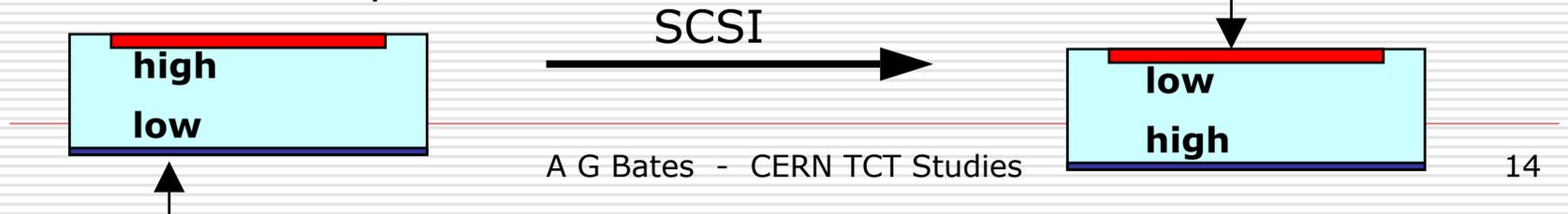
# SCSI in DOFZ



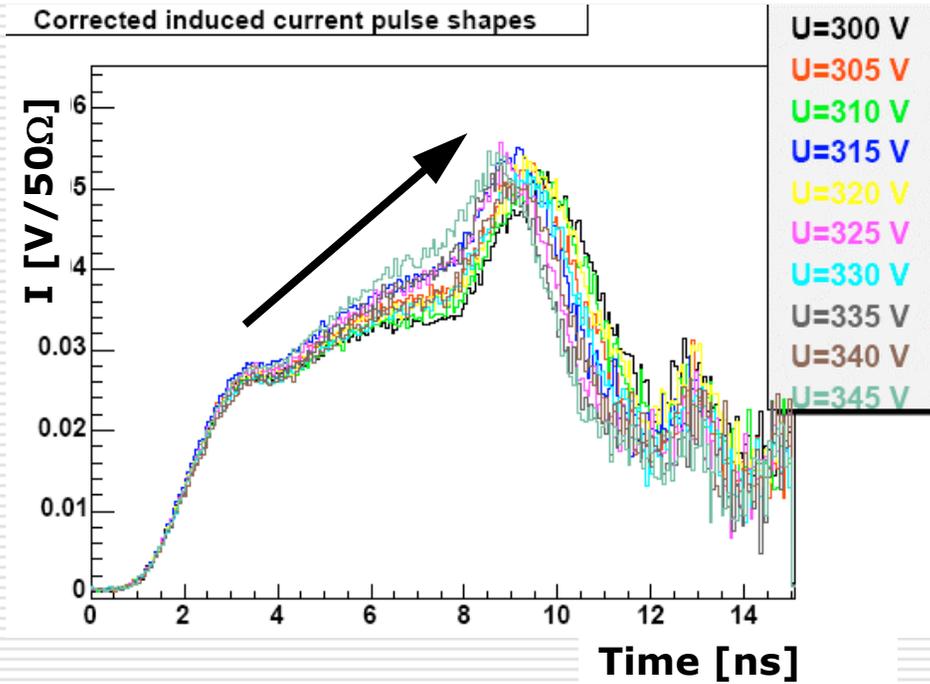
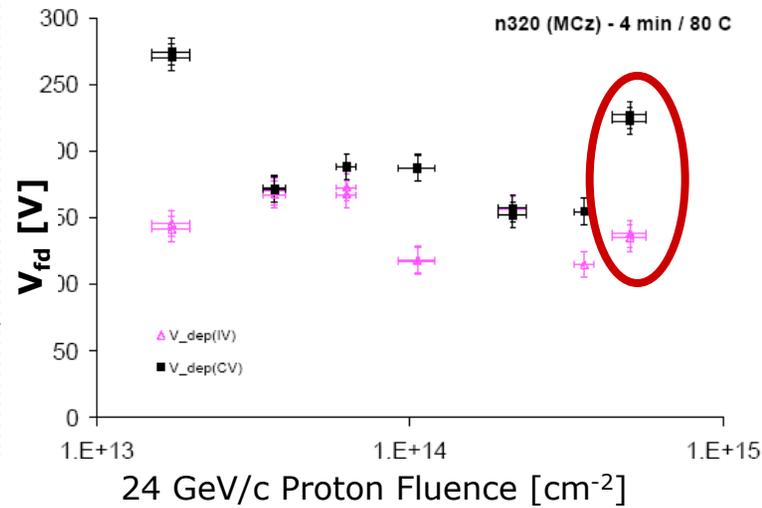
hole injection in DOFZ(d1) at  $\Phi = 2 \cdot 10^{13} \text{ p/cm}^2$



electron injection in DOFZ(d1) at  $\Phi = 5 \cdot 10^{14} \text{ p/cm}^2$



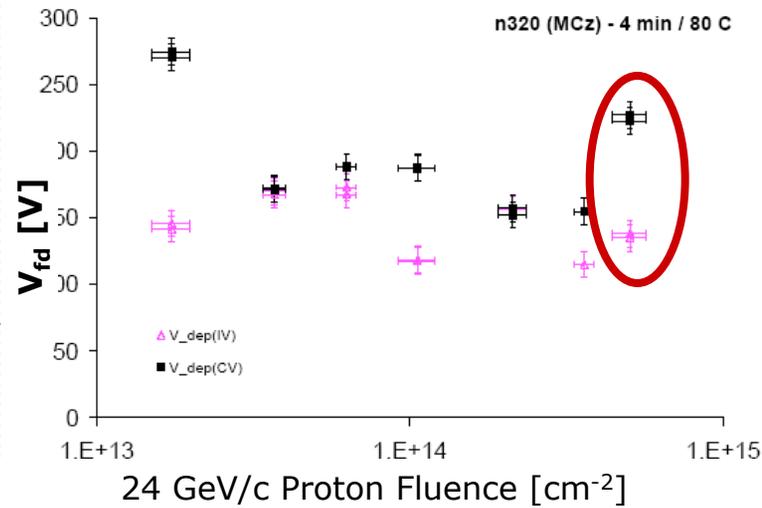
# SCSI in MCz? –No!



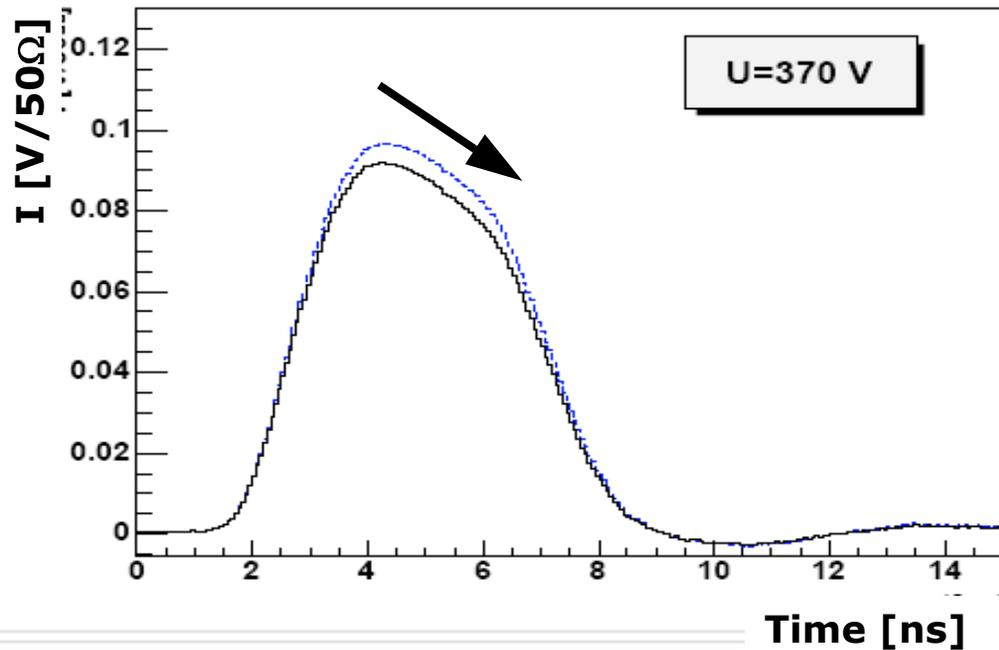
hole injection in MCz (n320) at  $\Phi = 5 \cdot 10^{14} \text{ p/cm}^2$



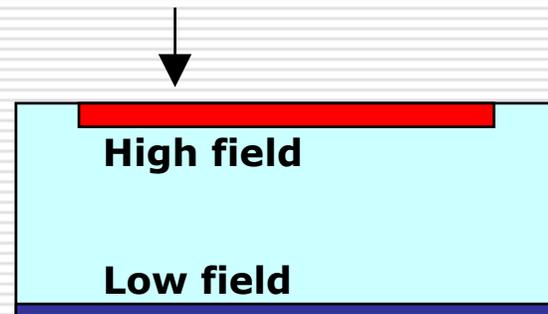
# SCSI in MCz? –No!



Corrected induced current pulse shapes



electron injection in MCz (n320)  
at  $\Phi = 5 \cdot 10^{14}$  p/cm<sup>2</sup>



# Summary

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- 4 materials studied in detail using IV/CV and TCT
  - Leakage current behaviour
  - IV/CV evolution of  $V_{fd}$  with  $\Phi$
  - $V_{fd}$  from QV method
  - $\beta$  value comparison with Dortmund, Hamburg and Ljubljana – agreement with Ljubljana
  - Examples of SCSI in DOFZ (also seen in FZ)
  - Showed no SCSI in MCz
- Other studies (not shown):
  - CCE of MCz, FZ and DOFZ silicon
  - Temperature effects on trapping times
  - Annealing study for DOFZ and MCz silicon

(All of the above will be summarised in an RD50 paper)

# Signal treatment

- Deconvolution of the true signal from the measured signal

Measured signal = detector signal  $\otimes$  transfer function

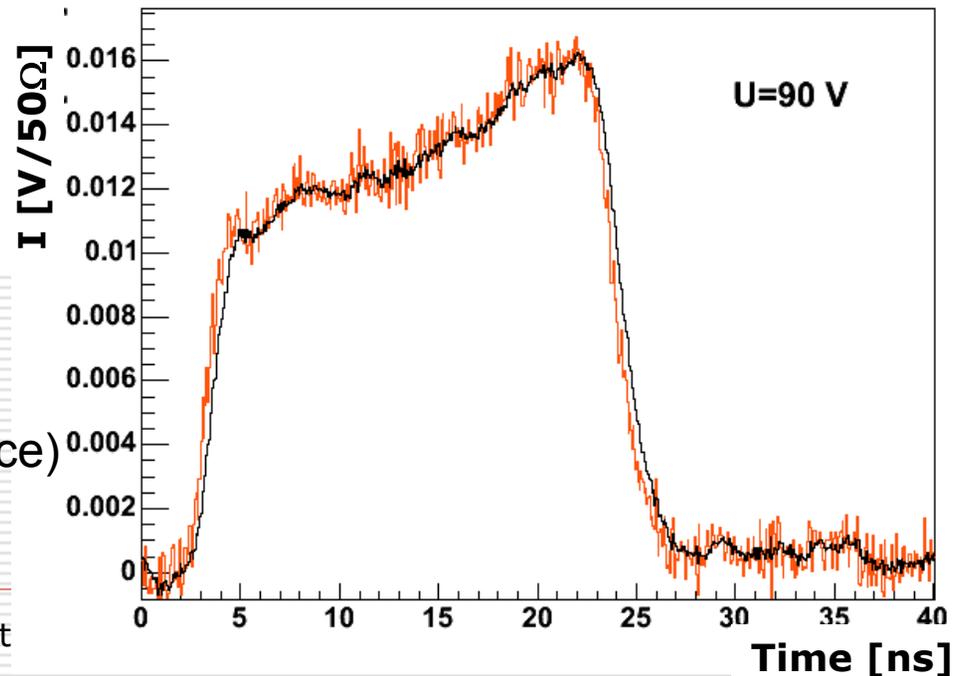
Transfer function:

$$I(t) = \tau_{\text{TCT}}/R \times dU_{\text{osc}}(t)/dt + U_{\text{osc}}(t)/R$$

$R = 50\Omega$  from input of preamp

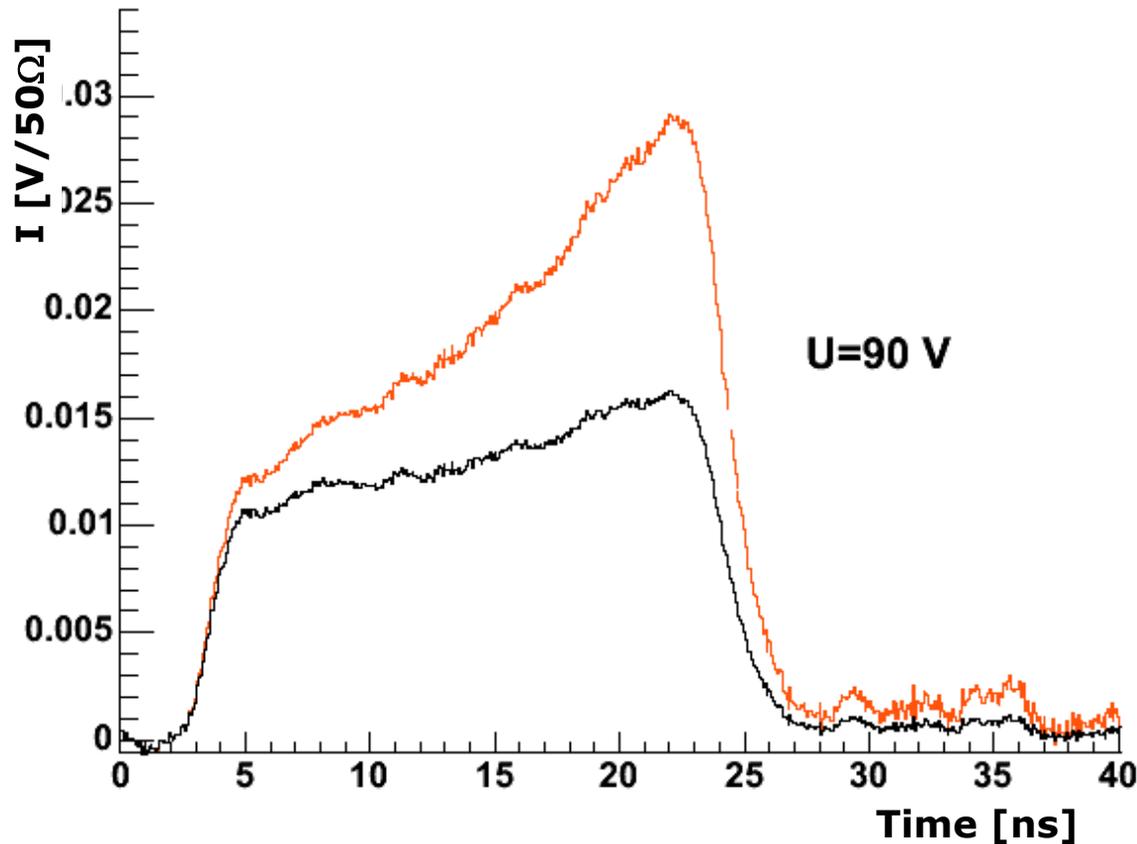
$$\tau_{\text{TCT}} = RC_d \quad (C_d = \text{detector capacitance})$$

TCT Measurement @ T=+05 C



# Back up slide 2 – signal examples

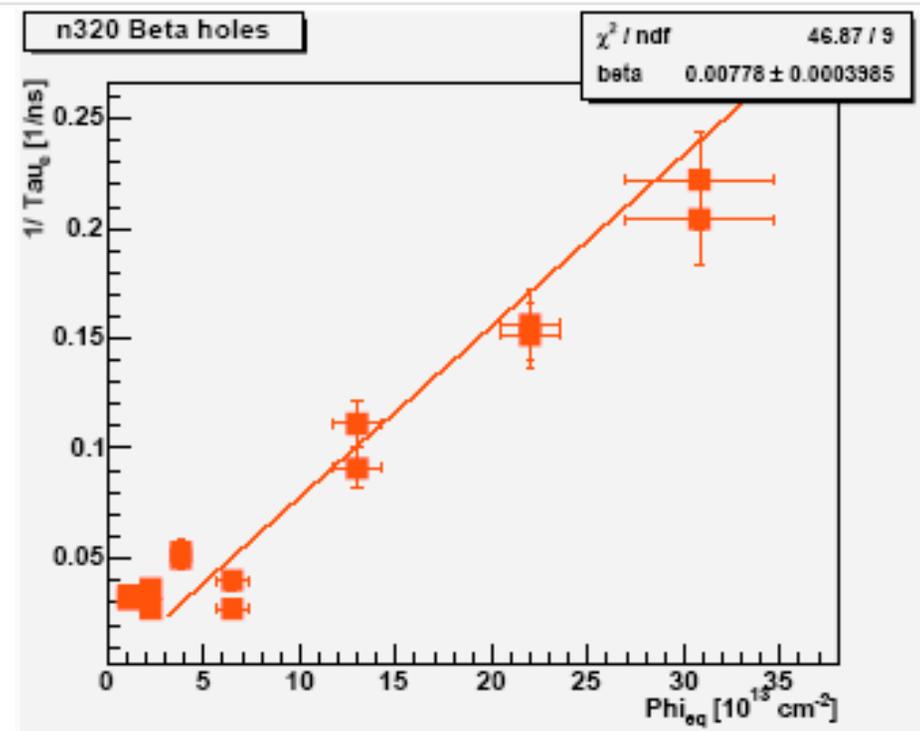
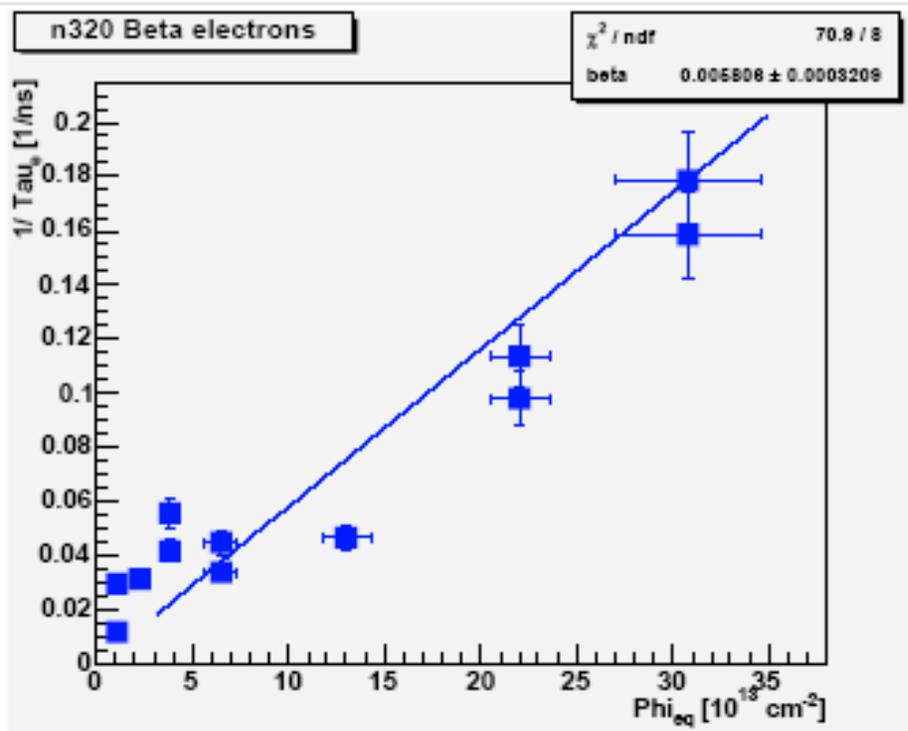
Corrected induced current pulse shapes



Black = signal as measured on the scope

Red = Trapping corrected signal

# MCz $\beta_{e,h}$ fits



# Electron injection in MCz at $1.7 \times 10^{13}$ p/cm<sup>2</sup>

## Corrected induced current pulse shapes

